

STP36N06
STP36N06FI

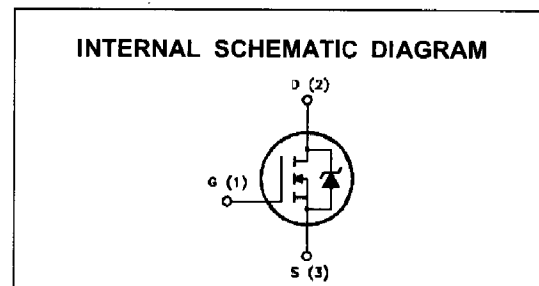
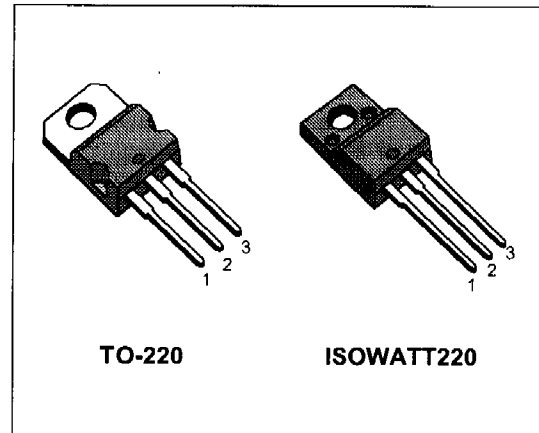
**N - CHANNEL ENHANCEMENT MODE
POWER MOS TRANSISTOR**

TYPE	V _{DS}	R _{DS(on)}	I _D
STP36N06	60 V	< 0.04 Ω	36 A
STP36N06FI	60 V	< 0.04 Ω	21 A

- TYPICAL R_{DS(on)} = 0.03 Ω
- AVALANCHE RUGGED TECHNOLOGY
- 100% AVALANCHE TESTED
- REPETITIVE AVALANCHE DATA AT 100°C
- LOW GATE CHARGE
- HIGH CURRENT CAPABILITY
- 175°C OPERATING TEMPERATURE
- APPLICATION ORIENTED CHARACTERIZATION

APPLICATIONS

- HIGH CURRENT, HIGH SPEED SWITCHING
- SOLENOID AND RELAY DRIVERS
- REGULATORS
- DC-DC & DC-AC CONVERTERS
- MOTOR CONTROL, AUDIO AMPLIFIERS
- AUTOMOTIVE ENVIRONMENT (INJECTION, ABS, AIR-BAG, LAMPDRIVERS, Etc.)

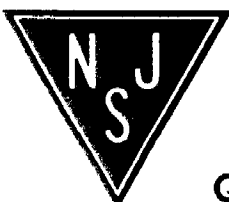


ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value		Unit
		STP36N06	STP36N06FI	
V _{DS}	Drain-source Voltage (V _{GS} = 0)	60		V
V _{DGR}	Drain- gate Voltage (R _{GS} = 20 kΩ)	60		V
V _{GS}	Gate-source Voltage	± 20		V
I _D	Drain Current (continuous) at T _c = 25 °C	36	21	A
I _D	Drain Current (continuous) at T _c = 100 °C	25	14	A
I _{DM} (*)	Drain Current (pulsed)	144	144	A
P _{tot}	Total Dissipation at T _c = 25 °C	120	40	W
	Derating Factor	0.8	0.27	W/°C
V _{ISO}	Insulation Withstand Voltage (DC)	—	2000	V
T _{stg}	Storage Temperature	-65 to 175		°C
T _j	Max. Operating Junction Temperature	175		°C

(*) Pulse width limited by safe operating area

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THERMAL DATA

				TO-220	ISOWATT220	
R _{thj-case}	Thermal Resistance Junction-case	Max		1.25	3.75	^o C/W
R _{thj-amb}	Thermal Resistance Junction-ambient	Max		62.5		^o C/W
R _{thc-sink}	Thermal Resistance Case-sink	Typ		0.5		^o C/W
T _l	Maximum Lead Temperature For Soldering Purpose			300		^o C

AVALANCHE CHARACTERISTICS

Symbol	Parameter	Max Value	Unit
I _{AR}	Avalanche Current, Repetitive or Not-Repetitive (pulse width limited by T _j max, δ < 1%)	36	A
E _{AS}	Single Pulse Avalanche Energy (starting T _j = 25 ^o C, I _D = I _{AR} , V _{DD} = 25 V)	240	mJ
E _{AR}	Repetitive Avalanche Energy (pulse width limited by T _j max, δ < 1%)	60	mJ
I _{AR}	Avalanche Current, Repetitive or Not-Repetitive (T _c = 100 ^o C, pulse width limited by T _j max, δ < 1%)	25	A

ELECTRICAL CHARACTERISTICS (T_{case} = 25 ^oC unless otherwise specified)

OFF

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V _{(BR)DSS}	Drain-source Breakdown Voltage	I _D = 250 μA V _{GS} = 0	60			V
I _{DSS}	Zero Gate Voltage Drain Current (V _{GS} = 0)	V _{DS} = Max Rating V _{DS} = Max Rating x 0.8 T _c = 125 ^o C			1 10	μA μA
I _{GSS}	Gate-body Leakage Current (V _{DS} = 0)	V _{GS} = ± 20 V			± 100	nA

ON (*)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} I _D = 250 μA	2	2.9	4	V
R _{DS(on)}	Static Drain-source On Resistance	V _{GS} = 10V I _D = 18 A		0.03	0.04	Ω
I _{D(on)}	On State Drain Current	V _{DS} > I _{D(on)} x R _{DS(on)} max V _{GS} = 10 V	36			A

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
g _{fs} (*)	Forward Transconductance	V _{DS} > I _{D(on)} x R _{DS(on)} max I _D = 18 A	12	16		S
C _{iss}	Input Capacitance	V _{DS} = 25 V f = 1 MHz V _{GS} = 0		1130	1500	pF
C _{oss}	Output Capacitance			480	650	pF
C _{rss}	Reverse Transfer Capacitance			140	200	pF

ELECTRICAL CHARACTERISTICS (continued)

SWITCHING ON

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on Time	$V_{DD} = 25\text{ V}$ $I_D = 18\text{ A}$ $R_G = 50\ \Omega$ $V_{GS} = 10\text{ V}$ (see test circuit, figure 3)		45	65	ns
t_r	Rise Time			280	400	ns
$(di/dt)_{on}$	Turn-on Current Slope	$V_{DD} = 40\text{ V}$ $I_D = 36\text{ A}$ $R_G = 50\ \Omega$ $V_{GS} = 10\text{ V}$ (see test circuit, figure 5)		200		A/ μ s
Q_g	Total Gate Charge	$V_{DD} = 40\text{ V}$ $I_D = 36\text{ A}$ $V_{GS} = 10\text{ V}$		42	60	nC
Q_{gs}	Gate-Source Charge			11		nC
Q_{gd}	Gate-Drain Charge			21		nC

SWITCHING OFF

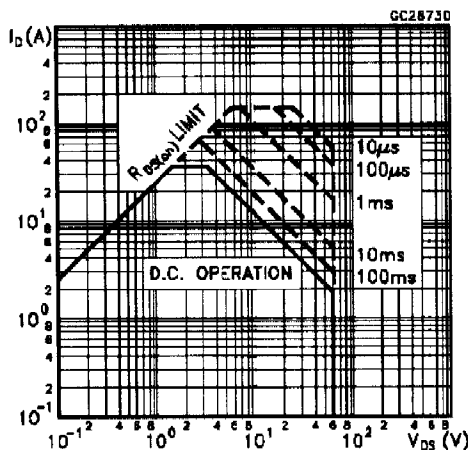
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$t_r(V_{off})$	Off-voltage Rise Time	$V_{DD} = 40\text{ V}$ $I_D = 36\text{ A}$ $R_G = 50\ \Omega$ $V_{GS} = 10\text{ V}$ (see test circuit, figure 5)		110	160	ns
t_f	Fall Time			105	150	ns
t_c	Cross-over Time			220	310	ns

SOURCE DRAIN DIODE

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I_{SD}	Source-drain Current				36	A
$I_{SDM}(\bullet)$	Source-drain Current (pulsed)				144	A
$V_{SD}(\ast)$	Forward On Voltage	$I_{SD} = 36\text{ A}$ $V_{GS} = 0$			1.5	V
t_{rr}	Reverse Recovery Time	$I_{SD} = 36\text{ A}$ $di/dt = 100\text{ A}/\mu\text{s}$ $V_{DD} = 30\text{ V}$ $T_j = 150\text{ }^\circ\text{C}$ (see test circuit, figure 5)		90		ns
Q_{rr}	Reverse Recovery Charge			0.2		μC
I_{RRM}	Reverse Recovery Current			4.5		A

(*) Pulsed: Pulse duration = 300 μ s, duty cycle 1.5 %
(\bullet) Pulse width limited by safe operating area

Safe Operating Areas For TO-220



Safe Operating Areas For ISOWATT220

